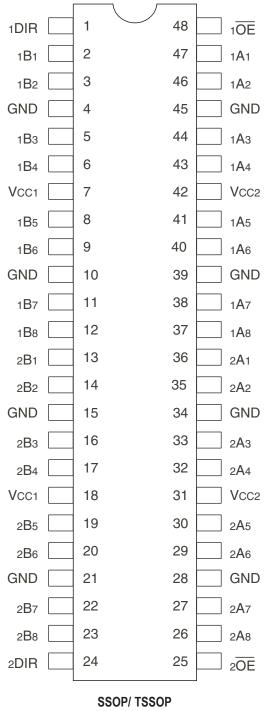
INDUSTRIAL TEMPERATURE RANGE

PIN CONFIGURATION



TOP VIEW

POWER SUPPLY SEQUENCING

In the 74FCT164245T, the condition of Vcc1 \ge (Vcc2 - 0.5V) must be maintained at all times. For the range of Vcc1 = (Vcc2 - 0.5V) to Vcc1 = (Vcc2 + 0.9V), both the A and B ports will remain in a High-Impedance state.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
VTERM ⁽²⁾	Terminal Voltage with Respect to GND	–0.5 to +7	V
VTERM ⁽³⁾	Terminal Voltage with Respect to GND	-0.5 to Vcc1+0.5	V
TA	Operating Temperature	-40 to +85	°C
TBIAS	Temperature Under Bias	–55 to +125	°C
Tstg	Storage Temperature	–55 to +125	°C
Рт	Power Dissipation	1	W
Ιουτ	DC Output Current	-60 to +120	mA

NOTES:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. All devices except Vcc2.

3. Power supply terminal Vcc2.

CAPACITANCE (TA = +25°C, F = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Тур.	Max.	Unit
CIN	Input Capacitance	VIN = 0V	3.5	6	pF
Ci/O	I/O Capacitance	Vout = 0V	3.5	8	pF

NOTE:

1. This parameter is measured at characterization but not tested.

PIN DESCRIPTION

Pin Names	Description
xOE Output Enable Input (Active LOW)	
xDIR Direction Control Input	
xAx	Side A Inputs or 3-State Outputs (3.3V Port)
xBx	Side B Inputs or 3-State Outputs (5V Port)

FUNCTION TABLE⁽¹⁾

Inputs		
xOE	xDIR	Outputs
L	L	Bus B Data to Bus A
L	Н	Bus A Data to Bus B
Н	Х	High Z State

NOTE:

1. H = HIGH Voltage Level

L = LOW Voltage Level

X = Don't Care

Z = High-Impedance

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE (A PORT, 3.3V)

Following Conditions Apply Unless Otherwise Specified:

VCC1 = 5V \pm 10%, VCC2 = 2.7V to 3.6V, Industrial: TA = -40°C to +85°C

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
VIH	Input HIGH Level (Input and I/O pins)	Guaranteed Logic HIGH Level		2	_	5.5	V
VIL	Input LOW Level (Input and I/O pins)	Guaranteed Logic LOW Lev	el	-0.5	_	0.8	V
Ін	Input HIGH Current (Input pins)	Vcc1 = Max.	VI = 5.5V	_	_	±5	
	Input HIGH Current (I/O pins)	Vcc2 = Max.	VI = VCC2	_	_	±15	μA
lı∟	Input LOW Current (Input pins)		VI = GND	_	_	±5	
	Input LOW Current (I/O pins)		VI = GND	_	_	±15	
Vik	Clamp Diode Voltage	Vcc2 = Min., IIN = –18mA	•		-0.7	-1.2	V
Vон	Output HIGH Voltage	VCC1 = VCC2 = Min.	Іон = -0.1mA	Vcc2-0.2	—	—	V
		VIN = VIH or VIL					
		Vcc2 = 3V	Iон = –8m А	2.4	3	—	
		VIN = VIH or VIL					
Vol	Output LOW Voltage	Vcc1 = Min.	IOL = 0.1mA	—	—	0.2	V
		Vcc2 = Min.	IOL = 16mA	—	0.2	0.4	
		VIN = VIH or VIL	IoL = 24mA	_	0.3	0.55	
		Vcc = 3V	IOL = 24mA	_	0.3	0.5	
		VIN = VIH or VIL					
IOFF	Input/Output Power Off Leakage	VCC1 = 0V, VCC2 = 0V, VIN or	Vo≤4.5V	—	_	±100	μA
los	Short Circuit Current ⁽⁴⁾	Vcc1 = Max., Vcc2 = Max., V	Vcc1 = Max., Vcc2 = Max., Vo = GND ⁽³⁾		-105	-150	mA
lo	Output Drive Current	VCC1 = Max., VCC2 = Max., VO = 1.5V ⁽³⁾		-40	-60	-90	mA
Vн	Input Hysteresis			_	150	_	mV
ICC2L	Quiescent Power Supply Current	Vcc1 = Max.			0.35	2	mA
Ісс2н		Vcc2 = Max.					
lcc2z		VIN = GND or VCC2					

NOTES:

1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.

2. Typical values are at Vcc1 = 5V, Vcc2 = 3.3V, $+25^{\circ}C$ ambient.

3. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.

4. This parameter is guaranteed but not tested.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE (B PORT, 5V)

Following Conditions Apply Unless Otherwise Specified:

VCC1 = 5V \pm 10%, VCC2 = 2.7V to 3.6V, Industrial: TA = -40°C to +85°C

Symbol	Parameter	Test Cond	Test Conditions ⁽¹⁾		Typ. ⁽²⁾	Max.	Unit
Vih	Input HIGH Level (Input and I/O pins)	Guaranteed Logic HIGH Lev	Guaranteed Logic HIGH Level		-	5.5	V
VIL	Input LOW Level (Input and I/O pins)	Guaranteed Logic LOW Lev	el	-0.5	_	0.8	V
Ін	Input HIGH Current (Input pins)	Vcc1 = Max.	VI = VCC1	_	_	±5	
	Input HIGH Current (I/O pins)	Vcc2 = Max.		_	_	±15	μA
lıL	Input LOW Current (Input pins)		Vi = GND	_	_	±5	1
	Input LOW Current (I/O pins)			_	_	±15	1
Viк	Clamp Diode Voltage	Vcc1 = Min., IIN = –18mA	•		-0.7	-1.2	V
Vон	Output HIGH Voltage	Vcc1 = Min.	Iон = –3mA	2.5	3.5	_	V
		Vcc2 = Min.	Iон = –15mA	2.4	3.5	_	1
		VIN = VIH or VIL	Iон = –32mA ⁽⁵⁾	2	3	_	1
Vol	Output LOW Voltage	Vcc1 = Min.	IOL = 64mA		0.2	0.55	V
		Vcc2 = Min.					
		VIN = VIH or VIL					
IOFF	Input/Output Power Off Leakage	VCC1 = 0V, VCC2 = 0V, VIN or	Vo≤4.5V	_	_	±100	μA
los	Short Circuit Current ⁽⁴⁾	Vcc1 = Max., Vcc2 = Max., V	Vcc1 = Max., Vcc2 = Max., Vo = GND ⁽³⁾		-140	-225	mA
lo	Output Drive Current	Vcc1 = Max., Vcc2 = Max., Vo = 2.5V ⁽³⁾		-50	-75	-180	mA
Vн	InputHysteresis	_		_	150	_	mV
ICC1L	Quiescent Power Supply Current	Vcc1 = Max.			0.08	1.5	mA
ICC1H		Vcc2 = Max.					
ICC1Z		VIN = GND or VCC2					

NOTES:

1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.

2. Typical values are at Vcc1 = 5V, Vcc2 = 3.3V, +25°C ambient.

3. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.

4. This parameter is guaranteed but not tested.

5. Duration of the condition cannot exceed one second.

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Condition	ons ⁽¹⁾	Min.	Typ. ⁽²⁾	Max.	Unit
Δlcc	Quiescent Power Supply Current TTL Inputs HIGH	Vcc1 = Max., Vcc2 = Max. VIN = Vcc2 - 0.6V ⁽³⁾		-	12	30	μA
ICCD	Dynamic Power Supply Current ⁽⁴⁾	Vcc1 = Max., Vcc2 = Max. Outputs Open xOE = xDIR = GND One Input Togging 50% Duty Cycle	VIN = VCC2 VIN = GND	_	75	120	μΑ/ MHz
lc	Total Power Supply Current ⁽⁶⁾	Vcc1 = Max., Vcc2 = Max. Outputs Open fl = 10MHz 50% Duty Cycle xOE = xDIR = GND One Bit Toggling	VIN = VCC2 - 0.6V VIN = GND	_	1.2	4.7	mA
		Vcc1 = Max., Vcc2 = Max. Outputs Open fi = 2.5MHz 50% Duty Cycle xOE = xDIR = GND Sixteen Bits Toggling	VIN = VCC2 - 0.6V VIN = GND	_	3.5	8.5(5)	

NOTES:

1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.

2. Typical values are at Vcc1 = 5V, Vcc2 = 3.3V, +25°C ambient.

3. Per TTL driven input. All other inputs at Vcc or GND.

4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.

5. Values for these conditions are examples of the Icc formula. These limits are guaranteed but not tested.

6. IC = IQUIESCENT + INPUTS + IDYNAMIC

IC = ICC1 + ICC2 + Δ ICC DHNT + ICCD (fCPNCP/2 + fiNi)

Icc1 = Quiescent Current (Icc1L, Icc1H and Icc1z)

ICC2 = Quiescent Current (ICC2L, ICC2H and ICC2Z)

 Δlcc = Power Supply Current for a TTL High Input

DH = Duty Cycle for TTL Inputs High

NT = Number of TTL Inputs at DH

ICCD = Dynamic Current caused by an Input Transition Pair (HLH or LHL)

fcp = Clock Frequency for Register Devices (Zero for Non-Register Devices)

NCP = Number of Clock Inputs at fCP

fi = Input Frequency

Ni = Number of Inputs at fi

SWITCHING CHARACTERISTICS OVER OPERATING RANGE(1)

Symbol	Parameter	Condition ⁽¹⁾	Min. ⁽²⁾	Max.	Unit
tPLH .	Propagation Delay	C∟ = 50pF	1.5	5	ns
t PHL	A to B	RL = 500Ω			
tPLH .	Propagation Delay		1.5	5	ns
t PHL	B to A				
tPZH	Output Enable Time		1.5	6.5	ns
tPZL	xOE to B				
tPHZ	Output Disable Time		1.5	6	ns
tPLZ	xOE to B				
tPZH	Output Enable Time		1.5	6.5	ns
tPZL	xOE to A				
tPHZ	Output Disable Time		1.5	6	ns
tPLZ	xOE to A				
tPZH	Output Enable Time		1.5	6.5	ns
tPZL	xDIR to B ⁽³⁾				
tPHZ	Output Disable Time		1.5	6	ns
tPLZ	xDIR to B ⁽³⁾				
tPZH	Output Enable Time		1.5	6.5	ns
tPZL	xDIR to A ⁽³⁾				
tPHZ	Output Disable Time		1.5	6	ns
tPLZ	xDIR to A ⁽³⁾				

NOTES:

1. See test circuit and waveforms.

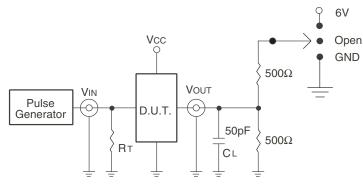
2. Minimum limits are guaranteed but not tested on Propagation Delays.

3. This parameter is guaranteed but not tested.

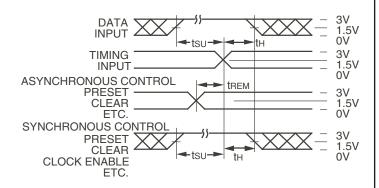
IDT74FCT164245T FAST CMOS 16-BIT BIDIRECTIONAL 3.3V TO 5V TRANSLATOR

INDUSTRIAL TEMPERATURE RANGE

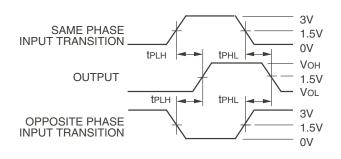
TEST CIRCUITS AND WAVEFORMS



Test Circuits for All Outputs



Set-up, Hold, and Release Times



Propagation Delay

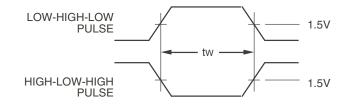
SWITCH POSITION

Test	Switch
Open Drain Disable Low Enable Low	6V
Disable High Enable High	GND
All Other Tests	Open

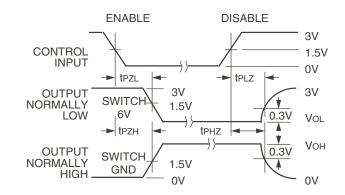
DEFINITIONS:

CL = Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to ZOUT of the Pulse Generator.



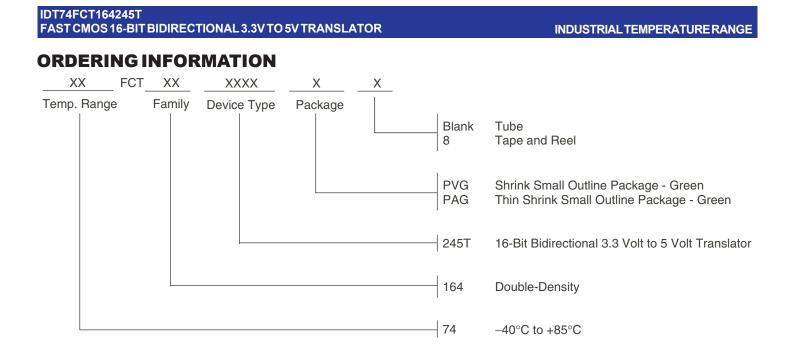
Pulse Width



Enable and Disable Times

NOTES:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH. 2. Pulse Generator for All Pulses: Rate \leq 1.0MHz; tF \leq 2.5ns; tR \leq 2.5ns.



DATASHEET DOCUMENT HISTORY

 09/28/2009
 pg. 8

 04/30/2015
 pgs. 3, 4 and 8

 05/12/2016
 pgs. 8

Updated the ordering information by removing the "IDT" notation and non RoHS part. Updated typo in DC Electrical Characteristics table and updated ordering information by adding Tape & Reel. Corrected temperature symbol and removed Tray from ordering information.

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